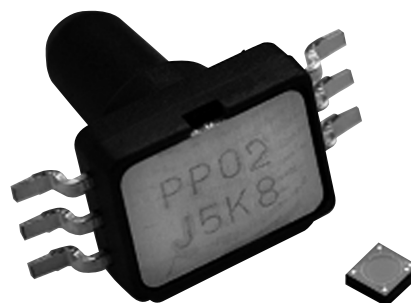


MEMS Gauge Pressure Sensor

2SMPP

MEMS Gauge Pressure Sensor Featuring Small Size and Low Power Consumption

- Ultra-miniature 6.1 × 4.7 × 8.2 mm (L × W × H).
- Piezo Resistive element provides electrical characteristics that are superior to capacitive type pressure sensors.
- 0 to 37 kPa pressure range.
- Low Power consumption of 0.2 mW
- Low Temperature Influence
- RoHS Compliant

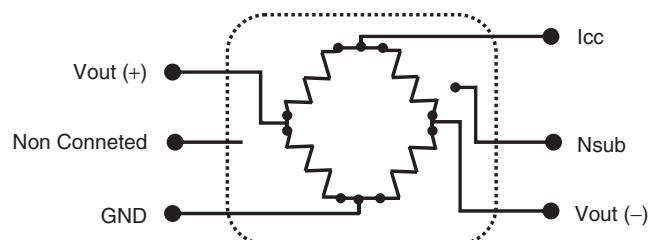


Ordering Information

Standard Models with Surface mount package

Classification	Structure	Packaging	Model
Bottom Port Type	SOP	Plastic sleeve	2SMPP-02

Terminal Arrangement



Application Examples

- Medical equipment
- Home appliance
- Air movement control
- Level indicators
- Leak detection
- Pressure controller

Specifications

■ Ratings

Item		2SMPP-02
Pressure type		Gauge Pressure
Sensing type		Piezo Resistive
Applicable gases		Air (Non-corrosive, dust free)
Ratings	Pressure range	0 to 37 kPa
	Withstand pressure	Max. 53 kPa
	Supply current	100 μ ADC
	Current consumption	Max. 130 μ ADC
	Ambient operating temperature	0 to 50°C (with no icing or condensation)
	Ambient operating humidity	15 to 90%RH (with no icing or condensation)
	Ambient storage temperature	-30 to 85°C (with no icing or condensation)
Ambient storage humidity		10 to 95%RH (with no icing or condensation)

Note: 1. The above values are initial values measured at ambient temperature condition of 23°C.
 2. Please avoid caustic gases.
 3. Standard product is not calibrated for negative pressures.

■ Electrical Characteristics

Item		2SMPP-02
Bridge resistance		$20 \pm 2 \text{ k}\Omega$
Offset voltage (See note 2.)		$-2.5 \pm 4.0 \text{ mV}$
Span voltage (See note 2.)		$31.0 \pm 3.1 \text{ mV}$ (at 37 kPa)
Non-Linearity (See note 2.)		$0 \pm 0.8\%$ FS (0 to 37 kPa)
Hysteresis (See note 2.)		$0 \pm 0.5\%$ FS (0 to 37 kPa)
Temperature influence of Span		$0.5 \pm 1.0\%$ FS (at 0°C)
		$0.3 \pm 1.0\%$ FS (at 50°C)
Temperature influence of Offset		$0 \pm 3.0\%$ FS (0 to 25°C)
		$0 \pm 3.0\%$ FS (25 to 50°C)

Note: 1. The above values are initial values measured at ambient temperature condition of 23°C.
 2. Not including temperature influence.

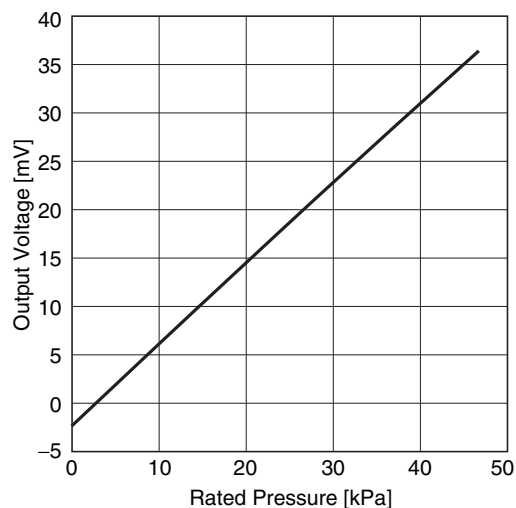
■ Environment Characteristics

Item		2SMPP-02
Vibration resistance	Destruction	10 Hz to 500 Hz 10 G
	Malfunction	10 Hz to 500 Hz 10 G
Shock resistance	Destruction	15 G
	Malfunction	15 G
Life Expectancy		300,000 Operations min. (0 to 39 kPa)
ESD		1000 V (Human body model)
Weight		0.17 g
Package Material		PPS (Polyphenylenesulfide)

Engineering Data (for reference)

■ Output Characteristics

Rated Pressure vs. Output Voltage



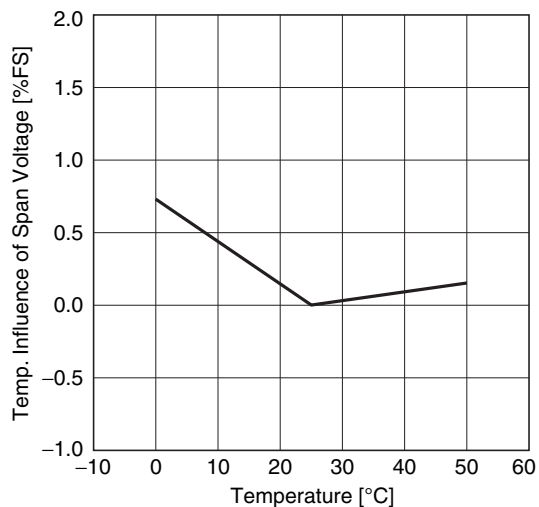
Note: 1. Ambient temperature condition: 25°C

2. Drive current: 100 μ A

3. These output voltage characteristics are measured with tester without a mounting board.

4. The output voltage characteristics may be influenced by the mounting board. Be sure to check operation including durability in actual equipment before use.

Temperature influence of Span voltage



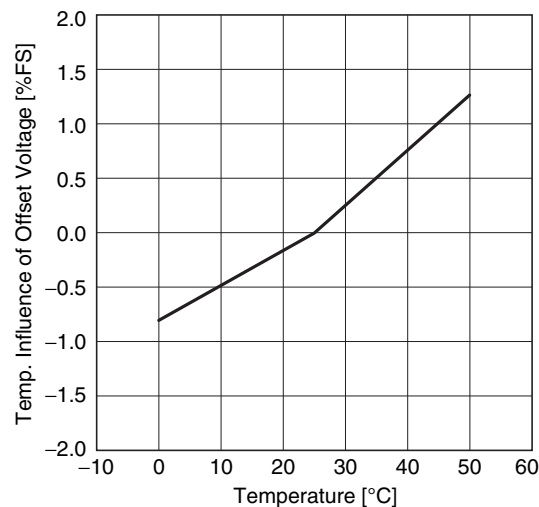
Note: 1. Measured points are 0°C and 25°C, 50°C

2. Drive current: 100 μ A

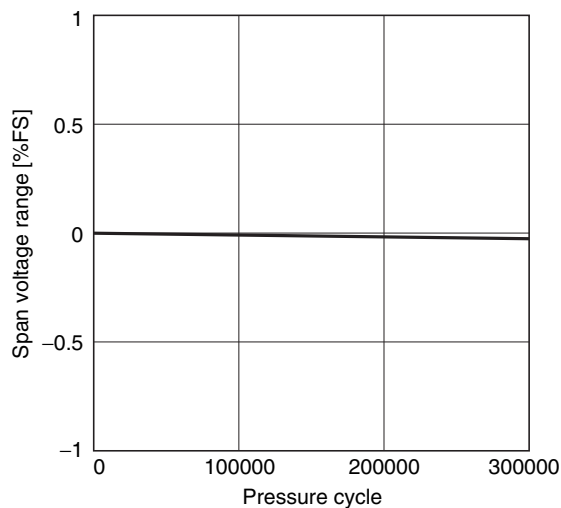
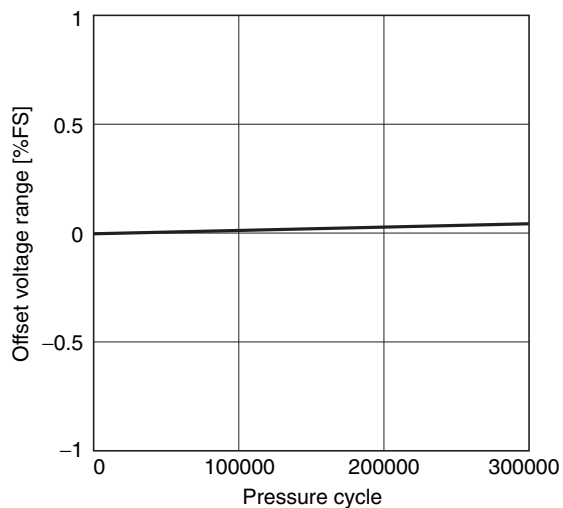
3. These output voltage characteristics are measured with tester without a mounting board.

4. The output voltage characteristics may be influenced by the mounting board. Be sure to check operation including durability in actual equipment before use.

Temperature influence of Offset voltage

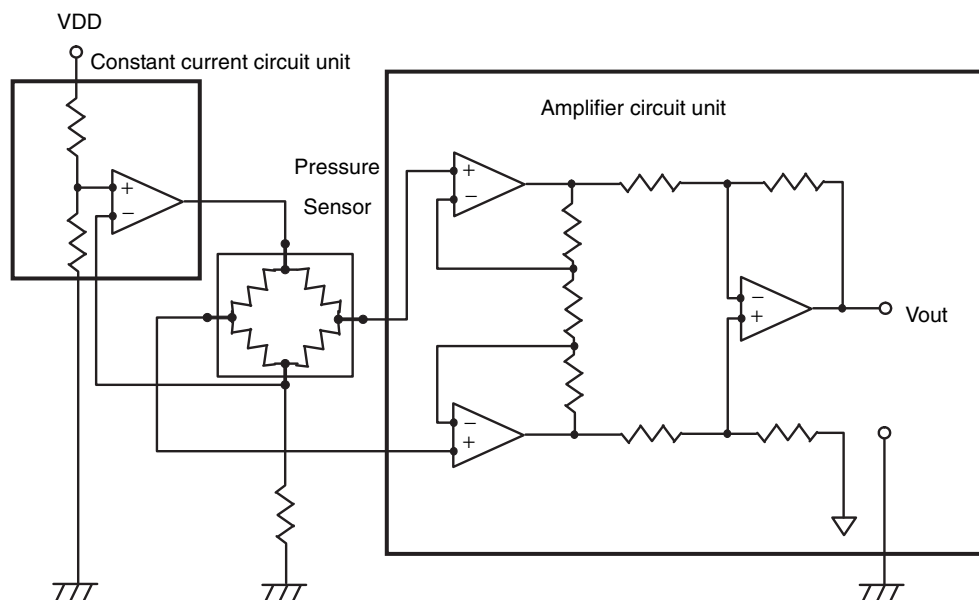


Pressure cycle range (0 to 40 kPa)



- Note:**
1. Tested temperature condition: 25°C
 2. Number of pressure cycle time: 3×10^5
 3. Rated cycle pressure: 0 to 40 kPa
 4. These output voltage characteristics are measured with tester without a mounting board.

Example of application circuit for MEMS Pressure Sensor

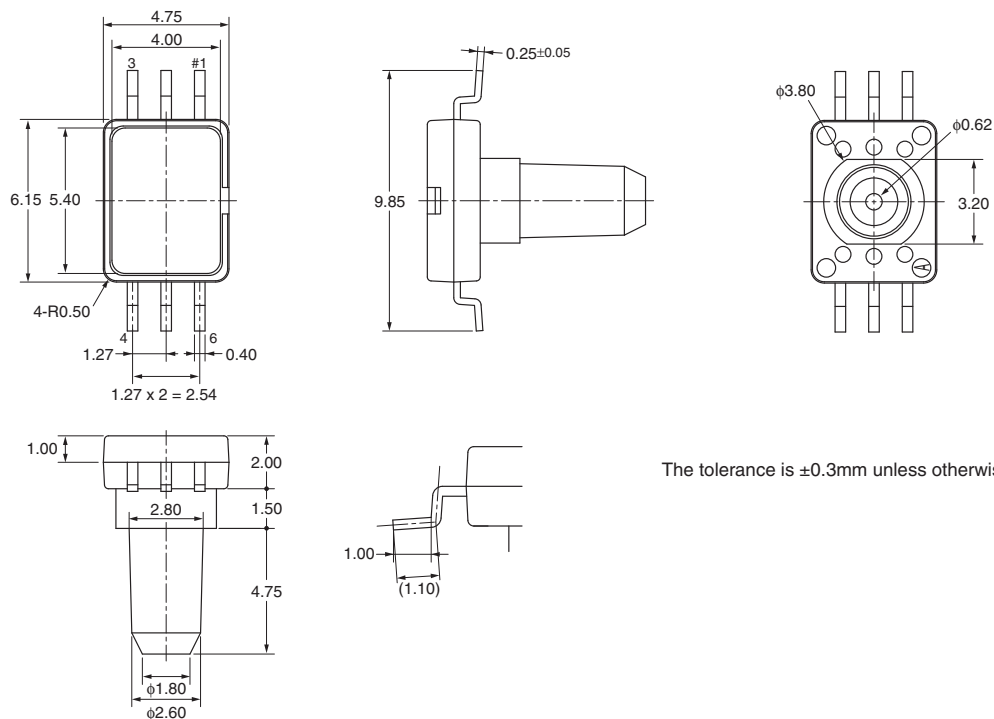


1. The pressure sensor is designed to convert a voltage by means of constant current drive.
2. Please amplify the output voltage of the pressure sensor by using the amplifying circuit if necessary.

Dimensions

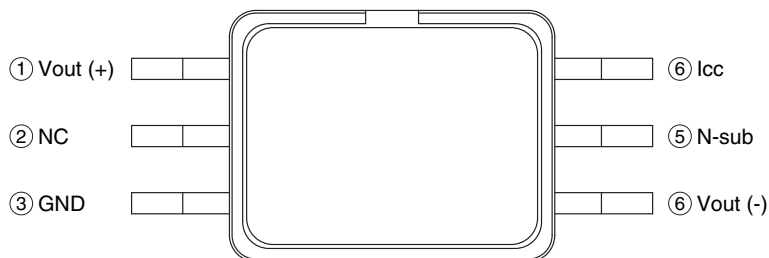
Note: All units are in millimeters unless otherwise indicated.

2SMPP-02

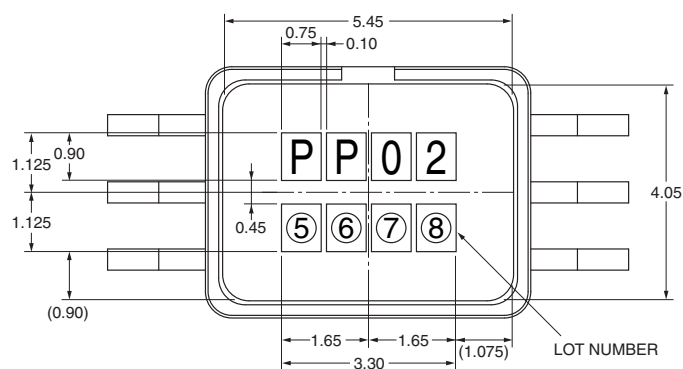


The tolerance is $\pm 0.3\text{mm}$ unless otherwise specified.

Top view



Marking



Precautions

■ Precautions for Correct Use

Handling

- Only air can be used as pressure media on the products directly. It is prohibited to use pressure media including corrosive gases (e.g. organic solvents gases, sulfur dioxide and hydrogen sulfide gases), fluid and any other foreign materials.
- The products are not water proof. Please keep dry in use.
- Don't use the products under dew-condensing conditions. Frozen fluid on sensor chips may also cause fluctuation of sensor output and other troubles.
- Don't put foreign materials (e.g. a wire or pin) into connecting tube. It may cause breakage of pressure sensor chips or fluctuation of sensor output caused by clogging the tube.
- Use the products within rated pressure. Usage at pressure out of the range may cause breakage.
- Don't use under high-frequency vibration including ultrasonic wave.
- The products may be broken by static electricity. Charged materials (e.g. a workbench and a floor) and workers must provide measures against static electricity, including ground connection.
- Overpowering terminals may deform them and detract their solderability. Don't drop or handle the products roughly.
- Don't use the products under humid or dusty condition.
- Terminals connection of pressure sensors must be handled as directed by a connection diagram.

Environmental Conditions for Transport and Storage

- It is prohibited to keep the products with corrosive gases (e.g. organic solvents gases, sulfur dioxide and hydrogen sulfide gases).
- The products are not water proof. Please keep dry during storage.
- An anti-static treatment has been applied to the sleeves. Please note the following points.
 1. Getting wet may remove an anti-static treatment and eliminate its effect.
 2. The sleeves may feel sticky under hot and humid condition due to the nature of the anti-static treatment.
 3. Anti-static has aging degradation. It is prohibited to keep the sleeves for more than six months. The sleeves are also non-reusable.
- Don't keep the products under humid or dusty condition.

Mounting

- Use lands on the printed-circuit boards to which the sensor can be securely fixed.
- Fix pin No.2 on the printed-circuit boards, not fixed causes fluctuation of sensor output signals.

Soldering

- Due to its small size, the thermal capacity of the pressure sensor is low. Therefore, take steps to minimize the effects of external heat.
- Dip soldering bath: Max.260°C, within 10 sec.
- Soldering iron: Max. 260°C, within 10 sec.
- Do not heat the case of sensor package, heat only terminal.
- Use a non-corrosive resin type of flux. Since the pressure sensor chip is exposed to the atmosphere, do not allow flux to enter inside.

Cleaning

- Since the pressure sensor chip is exposed to atmosphere, do not allow cleaning fluid to enter inside.
- Avoid ultrasonic cleaning since this may cause breaks or disconnections in the wiring.

Coating

- Do not coat the pressure sensor when it is mounted to the print circuit board.
- Do not wash the print circuit board after the pressure sensor is mounted using detergent containing silicone. Otherwise, the detergent may remain on the surface of the pressure sensor.

All sales are subject to Omron Electronic Components LLC standard terms and conditions of sale, which can be found at http://www.components.omron.com/components/web/webfiles.nsf/sales_terms.html

ALL DIMENSIONS SHOWN ARE IN MILLIMETERS.

To convert millimeters into inches, multiply by 0.03937. To convert grams into ounces, multiply by 0.03527.

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